

**SPECIFICATION FOR APPROVAL**

产品规格承认书

**SMD POWER INDUCTOR**

屏蔽电感

CUSTOMER.

MODEL NO.

KBH74-221M

CUSTOMER'S PART NO.

SDS74H-221M-LF

LILE NO.

20-099

DATE.

2020.02.24

REVISION.

A/0

CUSTOMER APPROVE

DATE:

DRAWING

DRAWN BY

CHECK BY

APPROVAL BY

殷荣忠

殷荣忠

范耀明

DATE:

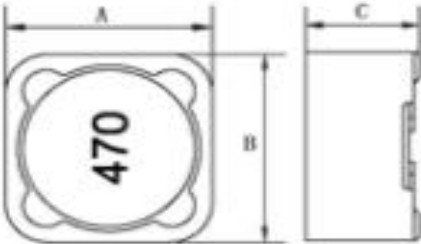
常州银河创新磁电有限公司

CHANGZHOU GALAXY INNOVATION MAGNETOELECTRICITYCO. , LTD



# 常州银河创新磁电有限公司

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<b>1.PRODUCT DIMENSION</b>	UNIT:mm	
	A	7.3±0.2
	B	7.3±0.3
	C	4.5MAX

<b>2.ELECTRICAL REQUIREMENTS</b>			
PARAMETER	SPECIFICATION	CONDITION	TEST INSTRUMENTS
L( uH)	220±20%	1KHz/0.25V	MICROTEST 6377
DCR(Ω)	2.2MAX	At 25℃	TH2512A
I sat(A)	0.66 TYP LOA* 70%	1KHz/0.25V	MICROTEST 6377+6220

**3.CHARACTERISTICS**

(1). All test data is based on 25℃ ambient.

(2). DC current(A)that will cause an approximate ΔT40℃

(3). DC current(A)that will cause L0 to drop approximately 10%Typ

(4). Operating temperature range: -55℃~+125℃

(5).The part temperature (ambient + temp rise)should not exceed 125℃ under worst case operating conditions. circuit design, component.PWB trace size and thickness,airflow and other cooling provision all affect the part temperature. Part temperature should be verified in the den application

**4.SPECIAL REQUEST**

(1)Lettering 221 on top of the body.

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## 5.PRODUCT IDENTIFICATION

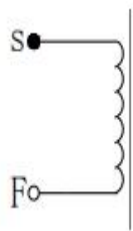
XX XXXX - XXX X X

①      ②      ③      ④      ⑤

①、 Product Symbol    ②、 Dimensions    ③、 Inductance

④、 Tolerance: M±20%, N±30%.    ⑤、 Material

## 6.ELECTRICAL SCHEMATICS



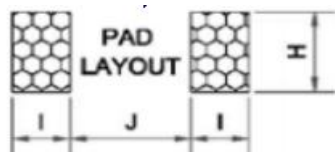
## 7.APPLICATION

- (1)Low profile,high current power supplies.
- (2)Battery powered devices.
- (3)DC/DC converters in distributed power systems.
- (5)DC/DC converters for field programmable gate array.

## 8.FEATURES

- (1)ROHS compliant.
- (2)Super low resistance,ultra high current rating.
- (3)high performance(l sat)realized by metal dust core.
- (4)Frequency Range:up to 1MHZ.

## 9.RECOMMENDED PCB LAYOUT



H	2.2TYP
I	1.6TYP
J	4.8TYP

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<b>3</b>					
项目Item	规格与需求 Specification and Requirement	测试方法Test Method			
可焊性 Solderability test	沾锡面积不得小于95%上锡面 Terminals area must have 95% min solder coverage	上锡升温曲线Solder heat proof: (1) 预热: 160±10℃持续90s Preheating: 160±10℃ for 90 seconds (2) 恒温时段: 245±5℃持续2±0.5s Retention time: 245±5℃ for 2±0.5 seconds			
振动测试 Vibration test	感值变化: 不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1) 振动频率(10Hz 55Hz 10Hz)60s为一个周期 Vibration frequency: (10Hz to 55Hz to 10Hz) in 60 seconds as a period (2) 振动时间 Vibration time: 三维正交坐标系每个方向振动(周期)循环2小时 Period cycled for 2 hours in each of 3 mutual perpendicular directions (3) 振幅 Amplitude: 1.5 mm Max			
冲击测试 Shock test	感值变化: 不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1) 最大振幅 Peak value: 100G (2) 脉冲波长 Duration of pulse: 11ms (3) 三维正交坐标系每个方向正负方向冲击3次 Times in each positive and negative direction of 3 mutual perpendicular directions			
冷热冲击 Thermal shock	感值变化: 不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1)重复以上100个循环Repeat 100 cycle as follow (-55±2℃,30±3分钟) 室温5分钟 (-55±2℃,30±3 minutes) Room temperature,5 minutes (+125±2℃,30±3分钟) 室温5分钟 (+125±2℃,30±3 minutes) Room temperature,5 minutes (2)恢复: 测试于标准条件下恢复48+4/-0小时(参考注释1) Recovery:48+4/-0 hours of recovery under the standard condition after the test. (see Note1)			
耐高温测试 High temperature life test	感值变化: 不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1)环境条件: 85±2℃ Environment condition : 85±2℃ 应用电流: 额定电流 Applied current: Rated current (2)持续时间: 1000+4/-0 小时(参考注释1) Duration:1000+4/-0 hours (see Note1)			
耐湿测试 Humidity Resistance	感值变化: 不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1)环境条件: 60±2℃ Environment condition : 60±2℃ 湿度: 90~95% Humidity:90~95% 应用电流: 额定电流 Applied current: Rated current (2)持续时间: 1000+4/-0 小时(参考注释1) Duration:1000+4/-0 hours (see Note1)			
低温存放测试 Low temperature life test	感值变化: 不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1)存储温度 Store temperature -55±2℃下存放 1000+4/-0 小时 -55±2℃for total 1000+4/-0 hours			
高温存放测试 High temperature life test	感值变化: 不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break	(1)存储温度 Store temperature +125±2℃下存放 1000+4/-0 小时 +125±2℃for total 1000+4/-0 hours			

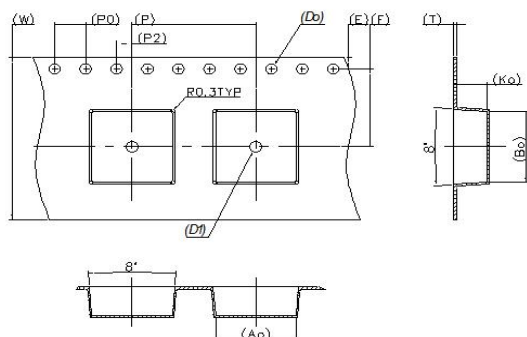
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## 12、包装 Packaging

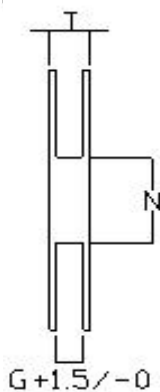
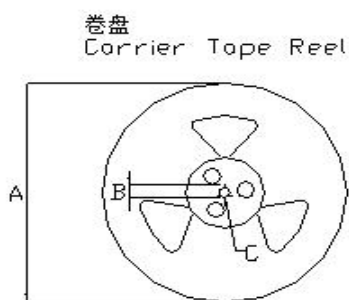
### 12.1、尺寸 Dimensions

#### 12.1.1 包装料带尺寸 Tape packaging dimensions



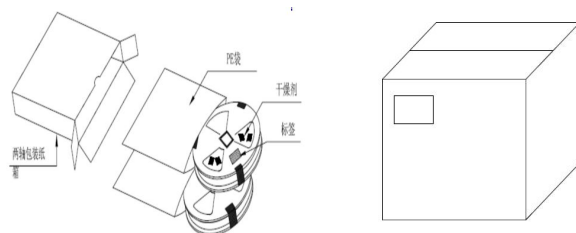
W	A0	B0	K0	E	F	P	D0	P0	T
24.00 ±0.30	10.6 ±0.10	10.7 ±0.10	4.1 ±0.10	1.75 ±0.10	11.5 ±0.05	16 ±0.10	1.5 ±0.10	4.0 ±0.10	0.35 ±0.03

#### 12.1.2 卷轴尺寸 Reel dimensions



项目	尺寸(mm)
A	330 ± 2.0
B	21 ± 1.0
C	13.5 ± 0.2
G	24 ± 1.5
N	100
T	28.4

#### 12.1.3 外箱尺寸 Carton dimensions



项目	数量 (PCS)
1卷轴	1000
1内箱	3000
1外箱	12000

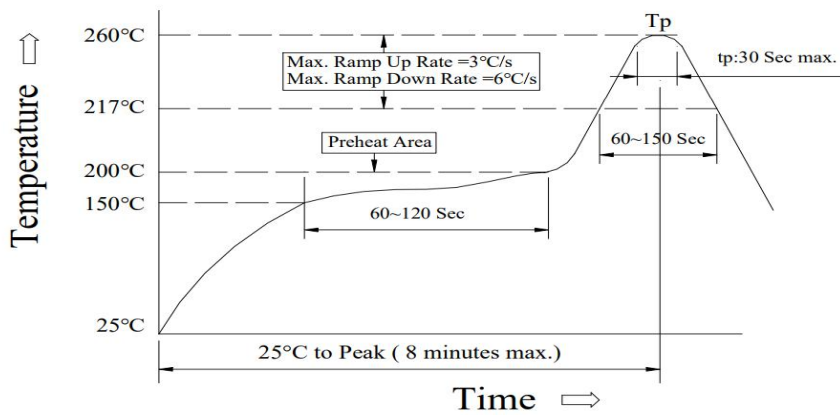
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## Reflow curve

### ※ Reflow Profile

### Power Choke Coil Type



### 1. Reflow Soldering Method

Reflow Soldering	Tp:255~260°C	Max.30 seconds ( tp )
	217°C	60~150 seconds
Pre-Heat	150 ~ 200°C	60~120 seconds
Time 25°C to peak temperature	8 minutes max.	

### 2. Soldering iron method : 350±5°C Max.3 seconds.